



RECOMMENDED PCB LAYOUT

PCB图仅供参考

Note:

- 1. Material:
 - 1.1 Housing: High temperature thermoplastic with g.f,UL94V-0
 - 1.2 Contact: copper alloy,t=0.20mm
 - 1.3 Shell: copper alloy or sus,t=0.25mm
- 2. Specification:
 - 2.1 Current rating:1.5PIN 1.8A Max/2,3,4PIN 1A Max voltage: 100 V(ac) for 1 min.
 - 2.2 Dielectric withstanding
 - 2.3 Contact resistance: 30 mΩ Max.
 - 2.4 Insulation resistance: 100 MΩ Min.
 - 2.5 Total mating force: 3.57 Kgf Max.
 - 2.6 Total unmating force: 1.0 Kgf Min.
 - 2.7 Temperature range: -30°C~80°C

- A 01 S B X X X X X X X XX-325**
- ① 外壳材质 1: C2680R-H
7: S1830AR-1/2H
 - ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ 端子电镀
01: Au1u'' ; 02: Au1.5u'' ; 03: Au3u''
05: Au5u'' ; 10: Au10u'' ; 15: Au15u'' ; 30: Au30u''
 - ⑫ ⑬ ⑭ ⑮ ⑯ ⑰ ⑱ ⑲ ⑳ ㉑ 主体颜色 B: 黑色
 - ⑳ ⑲ ⑳ ㉑ ㉒ 主体材质 1: LCP
 - ㉓ ㉔ ㉕ ㉖ ㉗ ㉘ ㉙ ㉚ ㉛ ㉜ ㉝ 端子材质 4: 05191R-4H
 - ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ ⑫ ⑬ ⑭ ⑮ ⑯ ⑰ ⑱ ⑲ ⑳ ㉑ ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ ⑫ ⑬ ⑭ ⑮ ⑯ ⑰ ⑱ ⑲ ⑳ ㉑ ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ ⑫ ⑬ ⑭ ⑮ ⑯ ⑰ ⑱ ⑲ ⑳ ㉑ ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ ⑫ ⑬ ⑭ ⑮ ⑯ ⑰ ⑱ ⑲ ⑳ ㉑ ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ ⑫ ⑬ ⑭ ⑮ ⑯ ⑰ ⑱ ⑲ ⑳ ㉑

PART NO.: A01SBXXXXXXXXX-325		MATERIAL: SEE NOTE	
MODEL NO.: XX		FINISH: SEE NOTE	
UNIT: MM	SIZE: A4	COLOR: SEE NOTE	
TOLERANCE UNSPECIFIED		DR: Xiayoulong	TITLE: Micro usb 5s B Type 有焊脚有框 插板式①6.4
.x	±0.15	CHK:	DWG NO.: A325
.xx	±0.10	APP:	SCALE: 5:1
.xxx	±0.05		DATE: 2012.06.06
Ang.	±1°		REV: A

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